

# DIP6, 1 Form A 1500V PhotoMOS Relay

# Description

The JOR258D6 photorelay consists of infrared light-emitting diode, photoelectric generator, and optical MOSFET coupling.



# Features

- Load voltage: 1,500 V
- Load current: 20 mA
- Distance between output terminals are longer than 6-pin DIP package

# Applications

- Isolation detection
- Voltage monitoring
- Signal control

#### **JOR258D6** Series

JieJie Microelectronics Co., Ltd. DIP6, 1 Form A 1500V PhotoMOS Relay

ABSOLUTE MAXIMUM RATINGS						
	PARAMETER	SYMBOL	Rating	UNIT		
	Forward Current		lf	20	mA	
Input	Reverse Voltage		Vr	6	V	
input	Junction Temperature		τJ	125	°C	
	Power Dissipation		Р	50	mW	
	Load voltage (peak AC)		VL	1500	V	
	Continuous load current		١L	20	mA	
Output	Peak load current		lpeak	60	mA	
	Junction Temperature		τJ	125	°C	
	Output Power Dissipation		Ро	360	mW	
	Total Power Dissipation			400	mW	
Isolation Voltage (Note 1)		Viso	5000	Vrms		
Operating Temperature		Topr	-40~+110	°C		
	Storage Temperature		Tsig	-55~+150	°C	
	Soldering Temperature (Note 2)		Tsol	260	°C	

Note: Ambient temperature = 25°C, unless otherwise specified. Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Note 1: AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

Note 2: For 10 Seconds

RECOMMENDED OPERATION CONDITIONS						
CH	IARACTERISTICS	SYMBOL	MIN.	MAX.	UNIT	
LED Forward Current		lf	5	15	mA	
JOR258D6	Load voltage (Peak AC)	VL	-	1200	V	
	Continuous load current	IL	-	20	mA	

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

ELECTRICAL OPTICAL CHARACTERISTICS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION		
INPUT CHARACTERISTICS								
Forward Voltage	VF	-	2.0	2.4	V	I <sub>F</sub> = 10 mA		
Reverse Current	IR	-	0.05	10	uA	Vr=5V		
OUTPUT CHARACTERISTICS								
Off state leakage current	llook	.eak - 0.1	0.1 10		IF=0mA			
	ILEAK			10	uA	VL = Max		
On resistance	Ron	- 2	270	500	V	IF=10mA		
On resistance						IL = Max		
COUPLE CHARACTERISTICS								
LED operate current	IFON	-	0.1	3	mA	IL=20mA		
LED turn off voltage	VFOFF	0.8	1.7		V	IL $\leq$ 10 $\mu$ A		
Turn on time	Том		- 0.1 1 ms IF=10m	1	mc	IF=10mA		
	TON	-		IL = Max				
Turn off time	Toff		0.1	0.2	ms	IF=10mA		
rum on time						IL = Max		







### JieJie Microelectronics Co., Ltd.

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MARKING INFORMATION						
JOR 258 YAWW	JOR : Company Abbr. 258 : Part Number Y : Fiscal Year A : Manufacturing Code WW : Work Week					
ORDERING INFORMATION	LABEL INFORMATION					
JOR258DX(Y)(Z)-G JOR – Company Abbr	▶ 捷捷微电(深圳)有限公司 JIEJIE MICROELECTRONICS (Shenzhen) Co Ltd					
258 – Part Number	Part No.:XXXXXXXXX Bin Code: X Lot No.: XXXXXXXXXX					
D – DIP or SMD Package						
X – 6(Pin Count)						
Y – Lead Form Option (SL/None)	Date Code: XXXX					
Z – Tape and Reel Option (T1/T2)	QTY: XXX PCS					
G – Green						

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#### **Precautions for Soldering**

#### IR Reflow soldering

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.



Time	(S)
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	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	S
Ramp-up rate (T∟ to T <sub>P</sub> )			3	°C/s
Liquidus temperature	T∟	21	°C	
Time above T∟	t∟	60	100	S
Peak Temperature	Τ <sub>Ρ</sub>		260	°C
Time during which T <sub>C</sub> is between (T <sub>P</sub> - 5) and T <sub>P</sub>	t₽		20	S
Ramp-down rate			6	°C/s

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